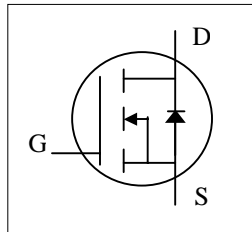
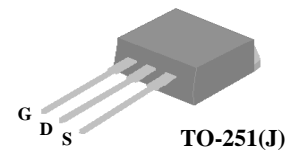




- ▼ 100% Avalanche Test
- ▼ Fast Switching Characteristics
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



|              |      |
|--------------|------|
| $BV_{DSS}$   | 600V |
| $R_{DS(ON)}$ | 8Ω   |
| $I_D$        | 1.6A |



## Description

AP01N60 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The straight lead version TO-251 package is widely preferred for all commercial-industrial through hole applications.

## Absolute Maximum Ratings @ $T_J=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                        | Parameter                                  | Rating     | Units            |
|-------------------------------|--|------------|------------------|
| $V_{DS}$                      | Drain-Source Voltage                       | 600        | V                |
| $V_{GS}$                      | Gate-Source Voltage                        | $\pm 30$   | V                |
| $I_D @ T_C=25^\circ\text{C}$  | Drain Current, $V_{GS} @ 10\text{V}$       | 1.6        | A                |
| $I_D @ T_C=100^\circ\text{C}$ | Drain Current, $V_{GS} @ 10\text{V}$       | 1          | A                |
| $I_{DM}$                      | Pulsed Drain Current <sup>1</sup>          | 6          | A                |
| $P_D @ T_C=25^\circ\text{C}$  | Total Power Dissipation                    | 39         | W                |
| $E_{AS}$                      | Single Pulse Avalanche Energy <sup>2</sup> | 13         | mJ               |
| $I_{AR}$                      | Avalanche Current                          | 1.6        | A                |
| $E_{AR}$                      | Repetitive Avalanche Energy                | 0.5        | mJ               |
| $T_{STG}$                     | Storage Temperature Range                  | -55 to 150 | $^\circ\text{C}$ |
| $T_J$                         | Operating Junction Temperature Range       | -55 to 150 | $^\circ\text{C}$ |

## Thermal Data

| Symbol | Parameter                                    | Value | Units                     |
|--------|--|-------|---------------------------|
| Rthj-c | Maximum Thermal Resistance, Junction-case    | 3.2   | $^\circ\text{C}/\text{W}$ |
| Rthj-a | Maximum Thermal Resistance, Junction-ambient | 110   | $^\circ\text{C}/\text{W}$ |



# AP01N60J-HF

## Electrical Characteristics @T<sub>j</sub>=25°C(unless otherwise specified)

| Symbol              | Parameter  | Test Conditions  | Min. | Typ. | Max. | Units |
|---------------------|--|--|------|------|------|-------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                       | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA               | 600  | -    | -    | V     |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>3</sup>       | V <sub>GS</sub> =10V, I <sub>D</sub> =0.8A               | -    | -    | 8    | Ω     |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                               | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA | 2    | -    | 4    | V     |
| g <sub>fs</sub>     | Forward Transconductance                             | V <sub>DS</sub> =50V, I <sub>D</sub> =0.8A               | -    | 0.8  | -    | S     |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                         | V <sub>DS</sub> =600V, V <sub>GS</sub> =0V               | -    | -    | 10   | uA    |
|                     | Drain-Source Leakage Current (T <sub>j</sub> =125°C) | V <sub>DS</sub> =480V, V <sub>GS</sub> =0V               | -    | -    | 100  | uA    |
| I <sub>GSS</sub>    | Gate-Source Leakage                                  | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V               | -    | -    | ±100 | nA    |
| Q <sub>g</sub>      | Total Gate Charge <sup>3</sup>                       | I <sub>D</sub> =1.6A                                     | -    | 7.7  | -    | nC    |
| Q <sub>gs</sub>     | Gate-Source Charge                                   | V <sub>DS</sub> =480V                                    | -    | 1.5  | -    | nC    |
| Q <sub>gd</sub>     | Gate-Drain ("Miller") Charge                         | V <sub>GS</sub> =10V                                     | -    | 2.6  | -    | nC    |
| t <sub>d(on)</sub>  | Turn-on Delay Time <sup>3</sup>                      | V <sub>DD</sub> =300V                                    | -    | 8    | -    | ns    |
| t <sub>r</sub>      | Rise Time  | I <sub>D</sub> =1.6A                                     | -    | 5    | -    | ns    |
| t <sub>d(off)</sub> | Turn-off Delay Time                                  | R <sub>G</sub> =10Ω                                      | -    | 14   | -    | ns    |
| t <sub>f</sub>      | Fall Time  | V <sub>GS</sub> =10V                                     | -    | 7    | -    | ns    |
| C <sub>iss</sub>    | Input Capacitance                                    | V <sub>GS</sub> =0V                                      | -    | 286  | -    | pF    |
| C <sub>oss</sub>    | Output Capacitance                                   | V <sub>DS</sub> =25V                                     | -    | 25   | -    | pF    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                         | f=1.0MHz   | -    | 5    | -    | pF    |

## Source-Drain Diode

| Symbol          | Parameter   | Test Conditions   | Min. | Typ. | Max. | Units |
|-----------------|---|---|------|------|------|-------|
| I <sub>S</sub>  | Continuous Source Current ( Body Diode )          | V <sub>D</sub> =V <sub>G</sub> =0V , V <sub>S</sub> =1.5V       | -    | -    | 1.6  | A     |
| I <sub>SM</sub> | Pulsed Source Current ( Body Diode ) <sup>1</sup> |   | -    | -    | 6    | A     |
| V <sub>SD</sub> | Forward On Voltage <sup>3</sup>                   | T <sub>j</sub> =25°C, I <sub>S</sub> =1.6A, V <sub>GS</sub> =0V | -    | -    | 1.5  | V     |

### Notes:

- 1.Pulse width limited by max. junction.
- 2.Starting T<sub>j</sub>=25°C , V<sub>DD</sub>=50V , L=10mH , R<sub>G</sub>=25Ω , I<sub>AS</sub>=1.6A.
- 3.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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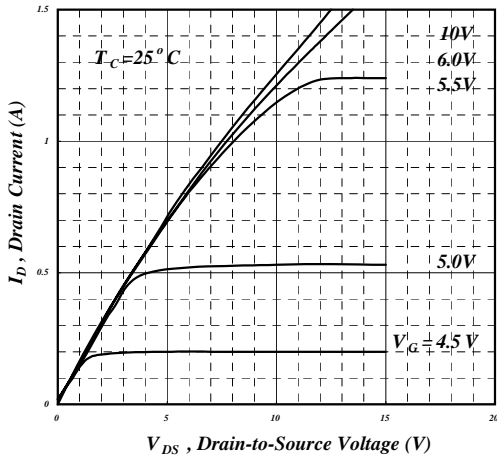


Fig 1. Typical Output Characteristics

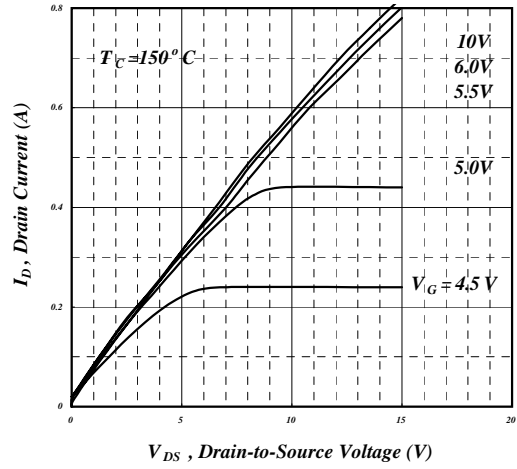


Fig 2. Typical Output Characteristics

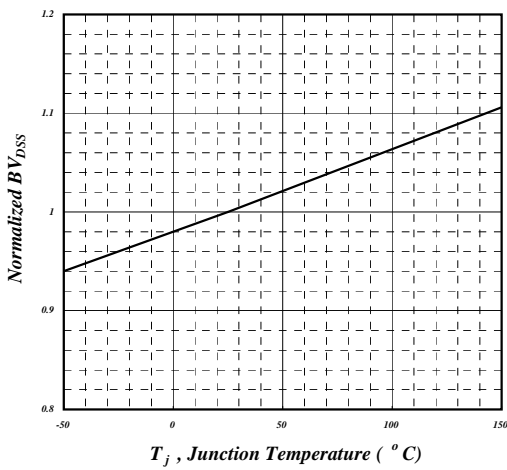


Fig 3. Normalized  $BV_{DSS}$  v.s. Junction Temperature

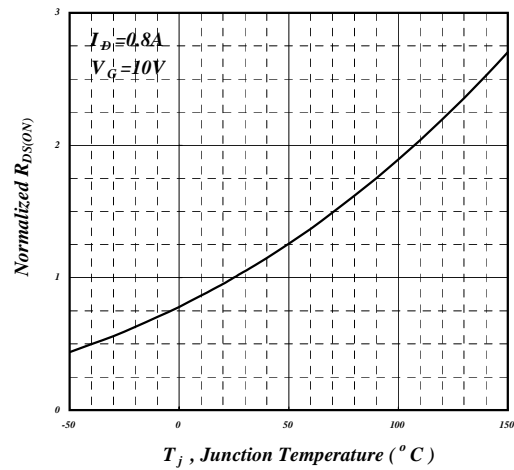


Fig 4. Normalized On-Resistance v.s. Junction Temperature

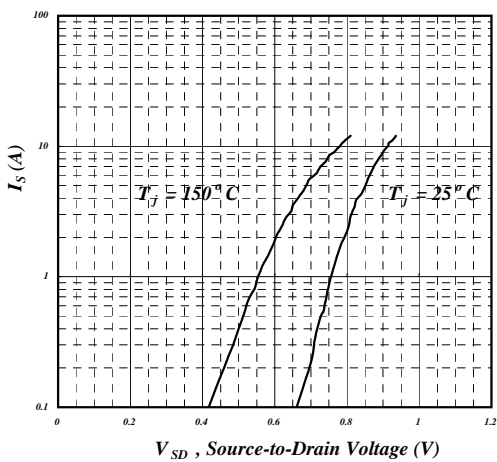


Fig 5. Forward Characteristic of Reverse Diode

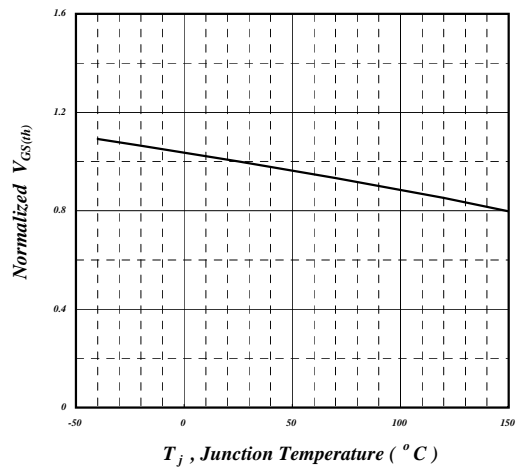


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

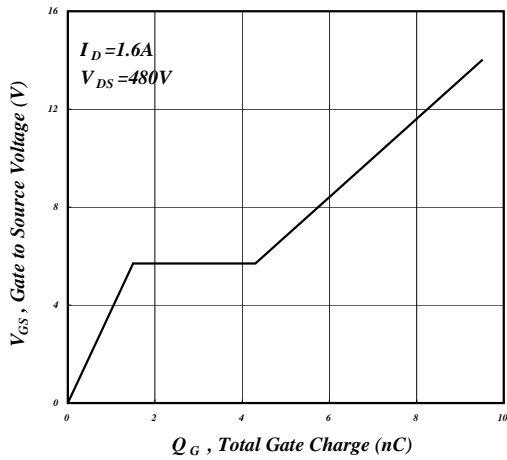


Fig 7. Gate Charge Characteristics

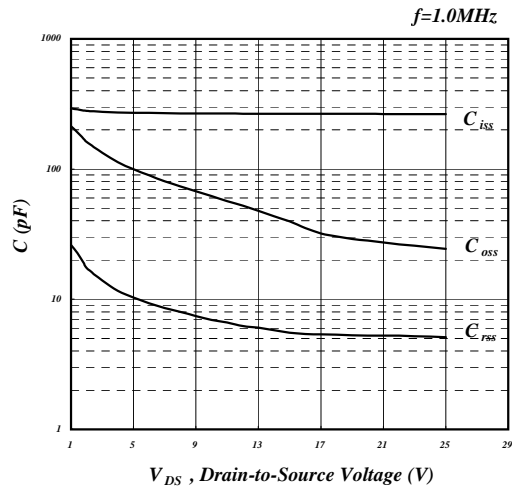


Fig 8. Typical Capacitance Characteristics

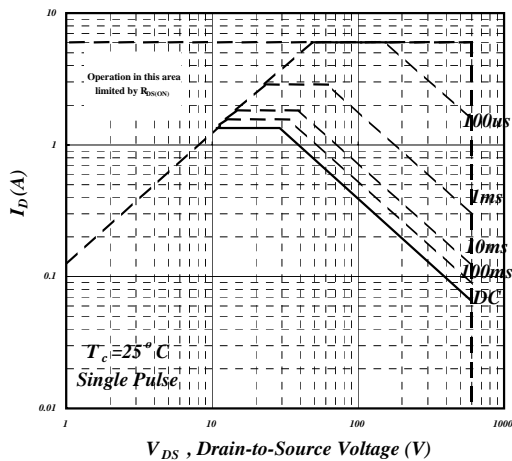


Fig 9. Maximum Safe Operating Area

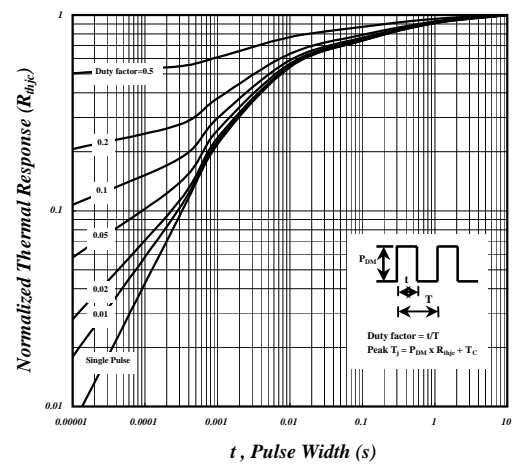


Fig 10. Effective Transient Thermal Impedance



Fig 11. Switching Time Waveform

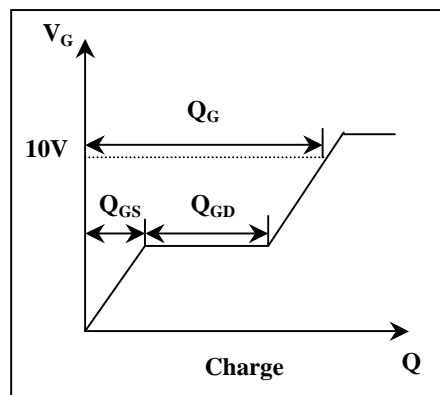


Fig 12. Gate Charge Waveform



# MARKING INFORMATION

